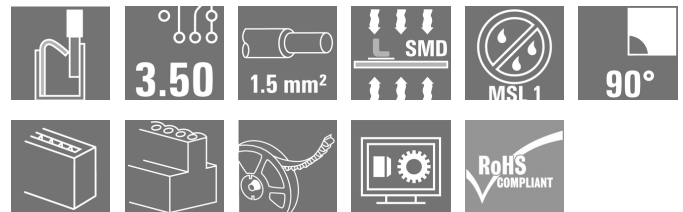
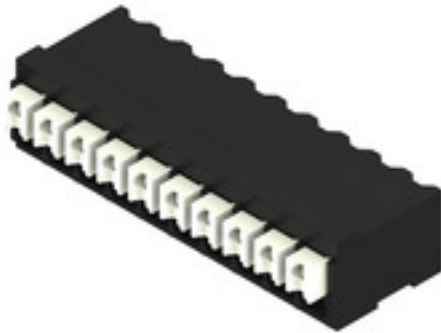


LSF-SMD 3.50/10/90 SN BK RL**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com**Product image****The innovative quick connector - simple, safe and economical:**

PCB terminals with spring connection and direct PUSH IN technology. A milestone in connection technology.

Amazingly simple and simply amazing in practice:

- Connect and easily detach solid wires or wires with wire-end ferrules without using tools
- Processed automatically in the reflow or vapour phase
- Potentials and clamping points marked clearly by coloured push buttons

World-class design-in and processing phases, and suitable for a vast range of applications.

PCB terminal for fully automatic assembly using reflow soldering (SMD), with PUSH IN wire connections. Conductor insertion and slider operation from the same direction (TOP).

- **Solid & flexible conductors with wire-end ferrules need only to be inserted and they are ready.**
- **When connecting stranded wires without wire-end ferrules the actuating element is used to open the terminal point**
- **Intuitive handling – since the wire-entry area and handling area are clearly separated.**
- **Packaged in tape-on-reel**
- **Conductor outlet direction 90°**

General ordering data

Version	Printed circuit board terminals, 3.50 mm, Number of poles: 10, 90°, black, PUSH IN with actuator, Clamping range, max.: 1.5 mm², Tape
Order No.	1473590000
Type	LSF-SMD 3.50/10/90 SN BK RL
GTIN (EAN)	4050118280258
Qty.	320 pc(s).
Product data	IEC: 320 V / 17.5 A / 0.2 - 1.5 mm² UL: 300 V / 12 A / AWG 28 - AWG 14
Packaging	Tape

LSF-SMD 3.50/10/90 SN BK RL

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Technical data

Dimensions and weights

Depth	14.75 mm	Depth (inches)	0.581 inch
Height	9.65 mm	Height (inches)	0.38 inch
Height of lowest version	9.65 mm	Width	35.7 mm
Width (inches)	1.406 inch	Net weight	6.41 g

Temperatures

Continuous operating temp., max.	120 °C
----------------------------------	--------

System parameters

Product family	OMNIMATE Signal - series LSF	Wire connection method	PUSH IN with actuator
Mounting onto the PCB	SMD solder connection	Conductor outlet direction	90°
Pitch in mm (P)	3.5 mm	Pitch in inches (P)	0.138 "
Number of poles	10	Pin series quantity	1
Fitted by customer	No	Number of rows	1
Coplanarity:	100 µm	Number of solder pins per pole	2
Stripping length	8 mm	L1 in mm	31.5 mm
L1 in inches	1.242 "	Touch-safe protection acc. to DIN VDE 0470	IP 20
Touch-safe protection acc. to DIN VDE 57 106	Safe from finger touch	Protection degree	IP20
Volume resistance	1.60 mΩ		

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Layer structure of solder connection	4...6 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	120 °C		

Conductors suitable for connection

Clamping range, min.	0.13 mm ²
Clamping range, max.	1.5 mm ²
Wire connection cross section AWG, min.	AWG 28
Wire connection cross section AWG, max.	AWG 14
Solid, min. H05(07) V-U	0.2 mm ²
Solid, max. H05(07) V-U	1.5 mm ²
Flexible, min. H05(07) V-K	0.2 mm ²
Flexible, max. H05(07) V-K	1.5 mm ²
w. plastic collar ferrule, DIN 46228 pt 4, 0.25 mm ² min.	
w. plastic collar ferrule, DIN 46228 pt 4, 0.75 mm ² max.	
w. wire end ferrule, DIN 46228 pt 1, min.	0.25 mm ²
w. wire end ferrule, DIN 46228 pt 1, max.	1.5 mm ²

Creation date May 21, 2024 8:06:53 AM CEST

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Technical data

Clampable conductor	Cross-section for conductor connection	Type	fine-wired
		nominal	0.25 mm ²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0.25/12 HBL
	Cross-section for conductor connection	Type	fine-wired
		nominal	0.34 mm ²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0.34/12 TK
	Cross-section for conductor connection	Type	fine-wired
		nominal	0.5 mm ²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0.5/14 OR
	Cross-section for conductor connection	Type	fine-wired
		nominal	0.75 mm ²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0.75/14T HBL

Reference text Length of ferrules is to be chosen depending on the product and the rated voltage., The outside diameter of the plastic collar should not be larger than the pitch (P)

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	17.5 A
Rated current, max. number of poles (Tu=20°C)	16 A	Rated current, min. number of poles (Tu=40°C)	17.5 A
Rated current, max. number of poles (Tu=40°C)	14 A	Rated voltage for surge voltage class / pollution degree II/2	320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 80 A

Rated data acc. to CSA

Institute (CSA)		Certificate No. (CSA)	200039-1664286
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A
Wire cross-section, AWG, min.	AWG 28	Wire cross-section, AWG, max.	AWG 14
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

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Technical data

Rated data acc. to UL 1059

Institute (cURus)



Certificate No. (cURus)

E60693

Rated voltage (Use group B / UL 1059) 300 V

Rated current (Use group B / UL 1059) 12 A

Wire cross-section, AWG, min. AWG 28

Reference to approval values Specifications are maximum values, details - see approval certificate.

Rated voltage (Use group D / UL 1059) 300 V

Rated current (Use group D / UL 1059) 10 A

Wire cross-section, AWG, max. AWG 14

Packing

ESD Level packaging static dissipative

VPE length 332 mm

VPE height 63 mm

Tape width (W) 56 mm

Tape pocket height (A0) 15.1 mm

Tape pocket separation (P1) 20 mm

Tape pocket separation (F) 26.2 mm

Surface resistance $R_s = 10^9 - 10^{12} \Omega$

Packaging Tape

VPE width 332 mm

Tape depth (T2) 10.9 mm

Tape pocket depth (K0) 10.4 mm

Tape pocket width (B0) 43.5 mm

Tape hole separation (E) 1.75 mm

Tape reel diameter \varnothing (A) 330 mm

Type tests

Test: Durability of markings	Test	mark of origin, type identification, pitch, approval marking UL, durability
Test: Clampable cross section	Standard	DIN EN 60999-1 section 7 and 9.1 / 12.00, DIN EN 60947-1 section 8.2.4.5.1 / 12.02
	Conductor type	Type of conductor and solid 0.14 mm ² conductor cross-section
		Type of conductor and stranded 0.14 mm ² conductor cross-section
		Type of conductor and solid 1.5 mm ² conductor cross-section
		Type of conductor and stranded 1.5 mm ² conductor cross-section
		Type of conductor and AWG 24/1 conductor cross-section
		Type of conductor and AWG 22/19 conductor cross-section
		Type of conductor and AWG 16/1 conductor cross-section
		Type of conductor and AWG 16/19 conductor cross-section
	Evaluation	passed

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Test for damage to and accidental loosening of conductors	Standard	DIN EN 60999-1 section 9.4 / 12.00
	Requirement	0.2 kg
	Conductor type	Type of conductor and AWG 24/1 conductor cross-section
		Type of conductor and AWG 24/19 conductor cross-section
	Evaluation	passed
	Requirement	0.3 kg
	Conductor type	Type of conductor and stranded 0.25 mm ² conductor cross-section
		Type of conductor and solid 0.5 mm ² conductor cross-section
	Evaluation	passed
	Requirement	0.4 kg
Pull-out test	Standard	DIN EN 60999-1 section 9.5 / 12.00
		≥10 N
	Conductor type	Type of conductor and AWG 24/1 conductor cross-section
		Type of conductor and AWG 24/19 conductor cross-section
	Evaluation	passed
	Requirement	≥20 N
		≥20 N
	Conductor type	Type of conductor and stranded 0.25 mm ² conductor cross-section
		Type of conductor and H05V-U0.5 conductor cross-section
	Evaluation	passed
	Requirement	≥40 N
		≥40 N
	Conductor type	Type of conductor and H07V-U1.5 conductor cross-section
		Type of conductor and H07V-K1.5 conductor cross-section
		Type of conductor and AWG 16/1 conductor cross-section
		Type of conductor and AWG 16/19 conductor cross-section
	Evaluation	passed

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Technical data

Classifications

ETIM 6.0	EC002643	ETIM 7.0	EC002643
ETIM 8.0	EC002643	ETIM 9.0	EC002643
ECLASS 9.0	27-44-04-01	ECLASS 9.1	27-44-04-01
ECLASS 10.0	27-44-04-01	ECLASS 11.0	27-46-01-01
ECLASS 12.0	27-46-01-01	ECLASS 13.0	27-46-01-01

Important note

IPC conformity Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- Additional push button colours on request
- Operating force of slider max. 40 N
- Rated current related to rated cross-section & min. No. of poles.
- Wire end ferrule with plastic collar to DIN 46228/4
- Wire end ferrule without plastic collar to DIN 46228/1
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Crimping shape "A" for wire end ferrules with PZ 6/5 crimping tool recommended.
- Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

Approvals

Approvals



ROHS	Conform
UL File Number Search	UL Website
Certificate No. (cULus)	E60693

LSF-SMD 3.50/10/90 SN BK RL**Weidmüller Interface GmbH & Co. KG**

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www.weidmueller.com**Technical data****Downloads**Approval/Certificate/Document of Con-
formity[Declaration of the Manufacturer](#)

Engineering Data

[CAD data – STEP](#)

Product Change Notification

[Changeover to ESD bags for "Tape on Reel" products](#)[Umstellung auf ESD-Beutel bei „Tape on Reel“ Produkten](#)

Catalogues

[Catalogues in PDF-format](#)

Brochures

[FL DRIVES EN](#)[PI OMNIMATE LSF SMD EN](#)[FL ANALO.SIGN.CONV. EN](#)[MB DEVICE MANUF. EN](#)[FL DRIVES DE](#)[FL BUILDING SAFETY EN](#)[FL APPL LED LIGHTING EN](#)[FL INDUSTR.CONTROLS EN](#)[FL MACHINE SAFETY EN](#)[FL HEATING ELECTR EN](#)[FL APPL INVERTER EN](#)[FL BASE STATION EN](#)[FL ELEVATOR EN](#)[FL POWER SUPPLY EN](#)[FL 72H SAMPLE SER EN](#)[PO OMNIMATE EN](#)

White paper surface mount technology

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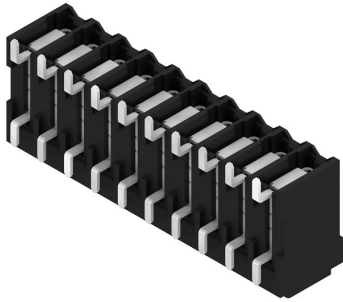
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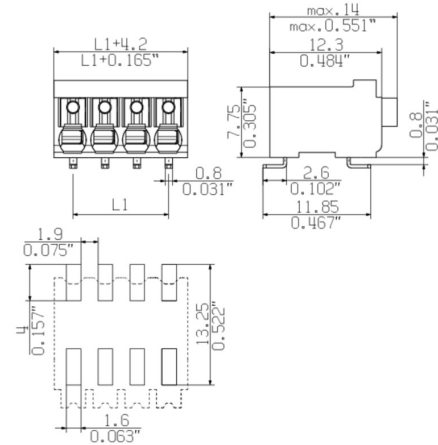
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Drawings

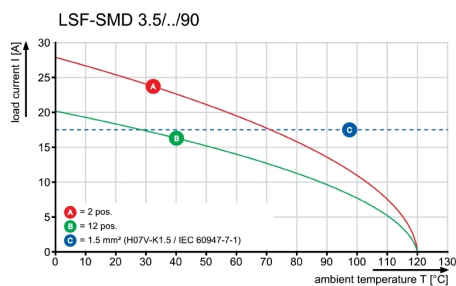
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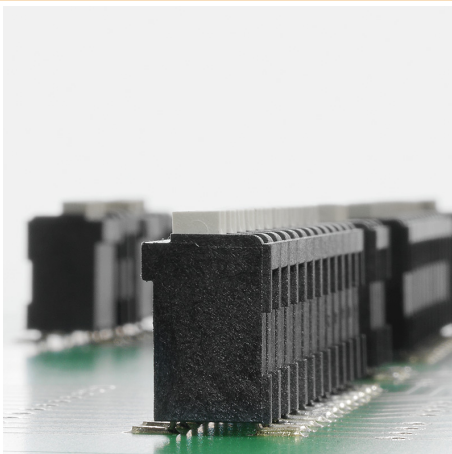
Dimensional drawing



Graph

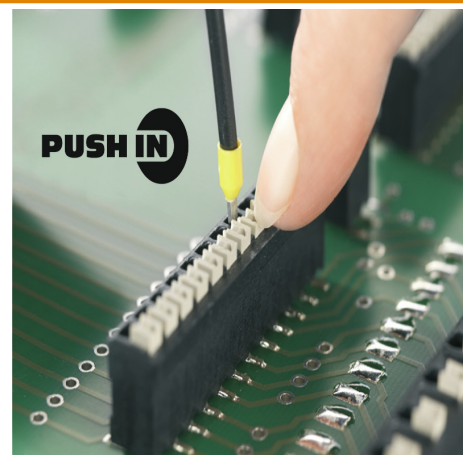


Product benefits



Stable solder connection

Product benefits



PUSH IN wire connection

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Drawings

Product benefits



Packaged in tape-on-reel

Dimensional drawing

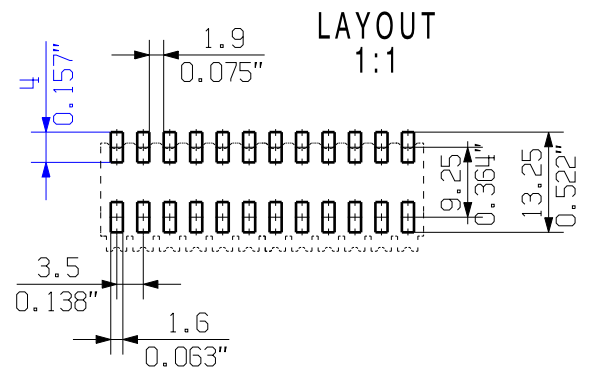
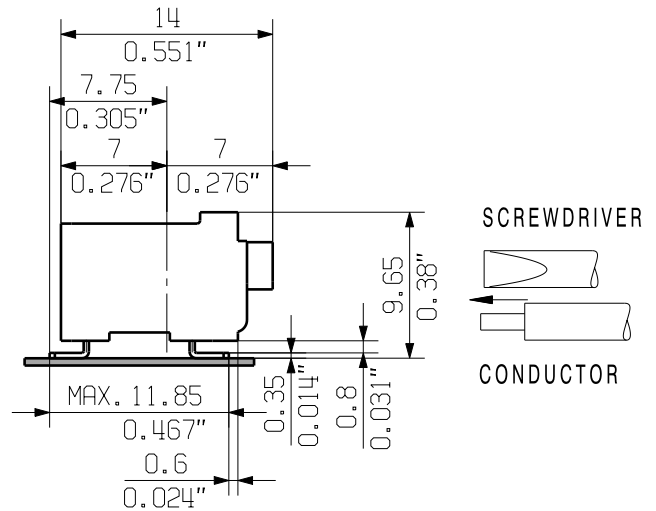
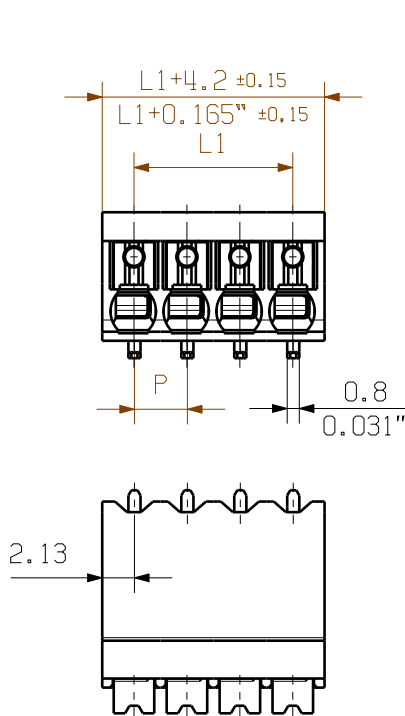


Dimensional drawing



MASSE OHNE TOLERANZ SIND KEINE PRUEFFMASSE
DIMS. WITHOUT TOLERANCE ARE NOT CONTROL DIMS.

DIE DEUTSCHE VERSION IST VERBINDLICH
THE GERMAN VERSION IS BINDING



P = PITCH
n = NO OF POLES

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components alone.

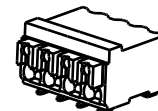
The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

SHOWN: LSF-SMD 3.50/04/90

1:1



12	38,5	1,516
11	35,0	1,378
10	31,5	1,240
9	28,0	1,102
8	24,5	0,965
7	21,0	0,827
6	17,5	0,689
5	14,0	0,551
4	10,5	0,413
3	7,0	0,276
2	3,5	0,138
n	L1 [mm]	L1 [Inch]

	ISO 2768-m	78005/5 09.09.14 HELIS_MA 00	CAT.NO.: . . .	
	MODIFICATION		C 56872 05	
	DATE	NAME	DRAWING NO. ISSUE NO.	
	DRAWN	11.02.2014	HELIS_MA	SHEET 01 OF 03 SHEETS
SCALE: 1:1	RESPONSIBLE	KRUG_M	LSF-SMD 3.50/./90...RL LEITERPLATTENKLEMM PCB TERMINAL	
	CHECKED	01.10.2014		
SUPERSEDES: .	APPROVED	LANG_T	PRODUCT FILE: LSF-SMD 7401	

Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com



Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.